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**** CONTINUING DATA *******

Loke This application is a 371 of PCT/JP03/03705 03/26/2003

**** FOREIGN APPLICATIONS *******

JAPAN 2002-090493 03/28/2002

Loke

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY JAPAN	SHEETS DRAWING 0	TOTAL CLAIMS 4	INDEPENDENT CLAIMS 2	
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after					
Verified and Acknowledged	Allowance <i>Steven Loke</i> Examiner's Signature	<i>SL</i> Initials			

ADDRESS

21839

TITLE

Pressure sensitive adhesive film for protection of semiconductor wafer surface and method of protecting semiconductor wafer with the pressure sensitive adhesive film

FILING FEE RECEIVED 920	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
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